



DT1140-04LP

Features

- Clamping Voltage: 9V at 10A 100ns TLP; 9V at 6A 8µs/20µs
- IEC 61000-4-2 (ESD): Air +20/-18kV, Contact +20/-16kV
- IEC 61000-4-5 (Lightning): ±6A (8/20µs)
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.5pF Typical
- TLP Dynamic Resistance: 0.25Ω
- Typically Used for High Speed Ports Such as USB 2.0, DVI[™]. HDMI[™], Ethernet Port, IEEE, MDDI, PCI Express[®], SATA/ eSATA
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2510-10
- Case Material: Molded Plastic, "Green" Molding Compound; • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead-Free Plating) Solderable per MIL-STD-202, Method 208 @4)

4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Weight: 0.038 grams (Approximate)

1, 2, 4, 5 I/O 6, 7, 9, 10 No Connection	<u> </u>	<u> </u>	L	- <u>Sa</u> . /	- Navi I. I			
6. 7. 9. 10 No Connection						Pin 1 Pin 2	Pin 4	Pin 5
	(****)	<u>۲۳۵</u>	-r ^C h	<u>۲</u> ۳۵	\sim	+ $+$ $+$ $ +$ $-$	$\mathbf{F}^{\circ} \mathbf{-}$	= 1
3, 8 V _{SS}	1	2	3	4	5			A

Pin Description (Top View)

Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel			
DT1140-04LP-7	AEC-Q101	BC2	7	8	3,000/Tape & Reel			
Notes: 1. No purposel	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS). 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.							

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

U-DFN2510-10



BC2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Kev

Date Coac no)												
Year	20	13	20	14	20	15	20	16	20	17	20	18
Code	A	١	E	3	()	[)	E		F	-
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current, per IEC 61000-4-5	IPP	6	А	I/O to V _{SS} , 8/20µs
Peak Pulse Power, per IEC 61000-4-5	P _{PP}	60	W	I/O to V _{SS} , 8/20µs
Operating Voltage (DC)	V _{DC}	6	V	I/O to V _{SS}
ESD Protection – Contact Discharge, per IEC 61000-4-2	Vesd_contact	+20/-16	kV	I/O to V _{SS}
ESD Protection – Air Discharge, per IEC 61000-4-2	V _{ESD_AIR}	+20/-18	kV	I/O to V _{SS}
Operating Temperature	T _{OP}	-55 to +85	°C	—
Storage Temperature	T _{STG}	-55 to +150	°C	—

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation Typical (Note 5)	PD	350	mW
Thermal Resistance, Junction to Ambient Typical (Note 5)	$R_{ extsf{ heta}JA}$	360	°C/W

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

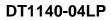
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V _{RWM}	_	—	5.5	V	I _R =1mA, , I/O to V _{SS}
Reverse Current (Note 6)	I _R	_	—	50	nA	$V_R = 5V$, I/O to V_{SS}
Reverse Breakdown Voltage	V _{BR}	6	_	_	V	$I_R = 1mA$, I/O to V _{SS}
Forward Clamping Voltage	VF	-1.0	-0.85	_	V	$I_F = -15 \text{mA}$, I/O to V_{SS}
Holding Voltage	V _H	5.5	_	_	V	—
Reverse Clamping Voltage (Note 7)	Vc	_	6.4	_	V	I _{PP} = 1A, I/O to V _{SS} , 8/20µs
Reverse Clamping Voltage (Note 7)	Vc	-	9	10	V	I _{PP} = 6A, I/O to V _{SS} , 8/20µs
Trigger Voltage	V _{TRIG}	-	_	9.5	V	—
ESD Clamping Voltage	V _{ESD}	_	9	—	V	TLP, 10A, t_P = 100ns, I/O to V _{SS}
Dynamic Reverse Resistance	R _{DIF-R}	_	0.25	_	Ω	TLP, 10A, t_P = 100ns, I/O to V _{SS}
Dynamic Forward Resistance	R _{DIF-F}	_	0.25	_	Ω	TLP, 10A, t_P = 100ns, V _{SS} to I/O
Channel Input Capacitance	C _{I/O}	_	0.5	0.65	pF	V _{I/O} = 2.5V, V _{SS} = 0V, f = 1MHz

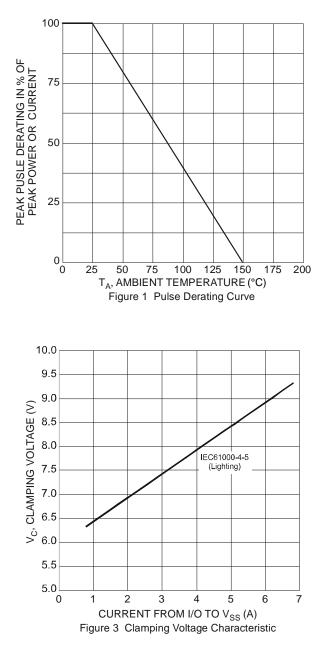
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

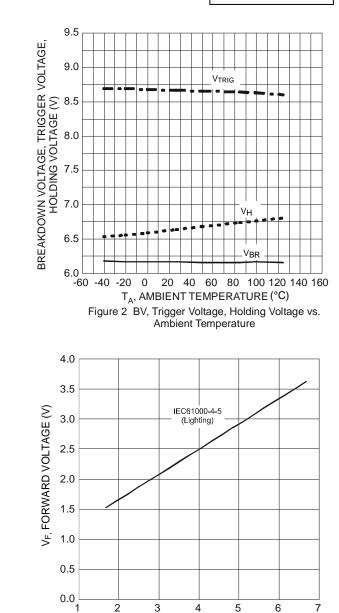
6. Short duration pulse test used to minimize self-heating effect.

7. Clamping voltage value is based on an $8x20\mu s$ peak pulse current (I_{pp}) waveform.



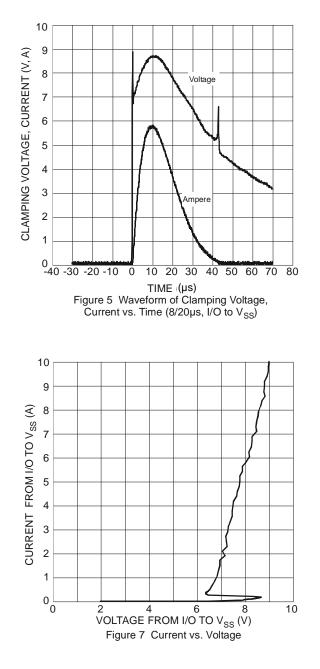


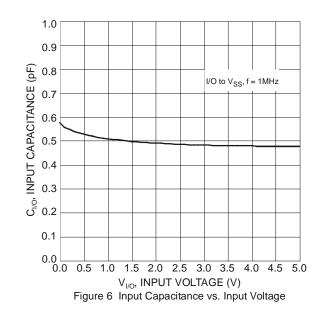




CURRENT FROM I/O TO V_{SS} (A) Figure 4 Forward Voltage Characteristic





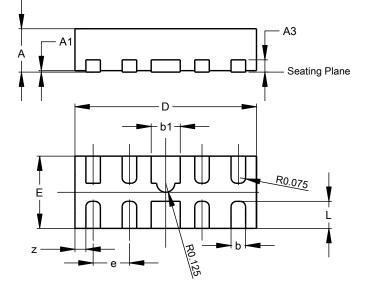




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

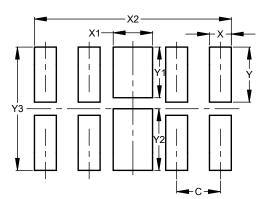
U-DFN2510-10



l	U-DFN2510-10								
Dim	Min	Max	Тур						
Α	0.545	0.605	0.575						
A1	0.00	0.05	0.03						
A3	-	-	0.13						
b	0.15	0.25	0.20						
b1	0.35	0.45	0.40						
D	2.450	2.575	2.500						
e	-	-	0.50						
E	0.950	1.075	1.000						
L	0.325	0.425	0.375						
z	-	-	0.150						
All D	imensi	ons in	mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



U-DFN2510-10

Dimensions	Value (in mm)
С	0.500
Х	0.250
X1	0.450
X2	2.250
Y	0.625
Y1	0.575
Y2	0.700
Y3	1.400



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